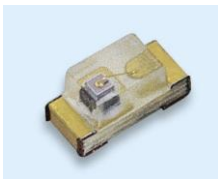


0.8mm Height Flat Top Infrared LED EAIST1608A2



Features

- High reliability
- Small double-end package
- Peak wavelength $\lambda_p=855\text{nm}$
- Package in 8mm tape on 7" diameter reel
- Low forward voltage
- Pb free
- The product itself will remain within RoHS compliant version.

Descriptions

- EAIST1608A2 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with flat top view lens.
- The device is spectrally matched with silicon photodiode and phototransistor.

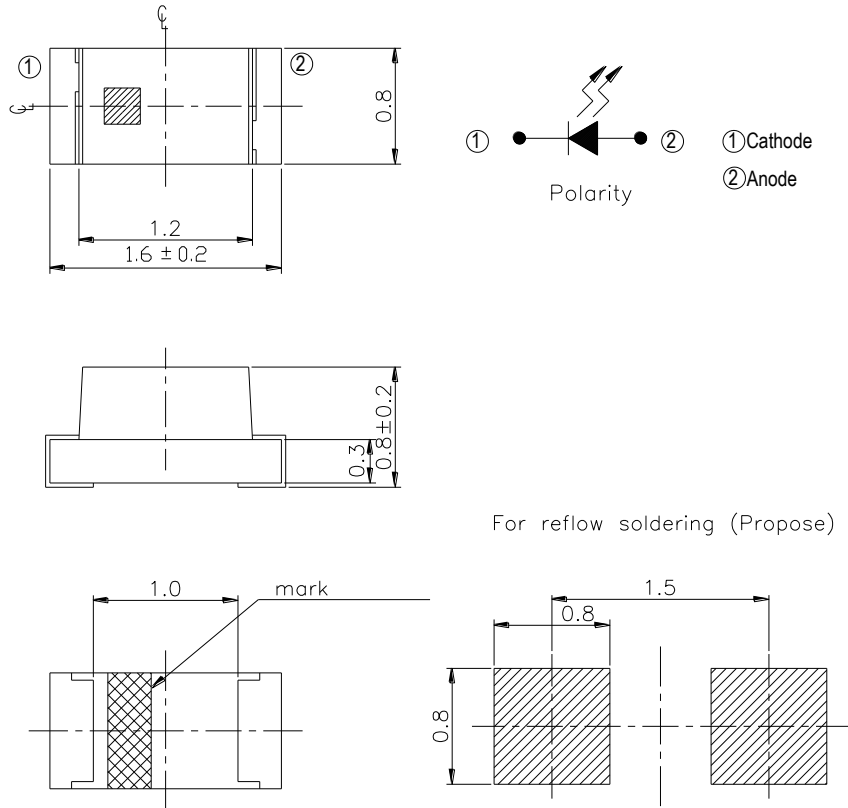
Applications

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Smoke detector
- Infrared applied system

Device Selection Guide

Part Category	Chip Material	Resin Color
EAIST1608A2	GaAlAs	Water clear

Package Dimensions



- Notes:** 1.All dimensions are in millimeters
2.Tolerances unless dimensions ±0.1mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units
Continuous Forward Current	I _F	65	mA
Peak Forward Current *1	I _{FP}	1.0	A
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-25 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Soldering Temperature *2	T _{sol}	260	°C
Power Dissipation at(or below) 25°C Free Air Temperature	P _d	130	mW

Notes: *1:I_{FP} Conditions--Pulse Width ≤ 100 μs and Duty ≤ 1%.

*2:Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Radiant Intensity	I _e	I _F =20mA	1.0	1.85	--	mW /sr
Peak Wavelength	λ _p	I _F =20mA	--	855	--	nm
Spectral Bandwidth	Δ λ	I _F =20mA	--	45	--	nm
Forward Voltage	V _F	I _F =20mA	--	1.45	1.65	V
Reverse Current	I _R	V _R =5V	--	--	10	μA
View Angle	2 θ 1/2	I _F =20mA	--	145	--	deg

Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.
Ambient Temperature

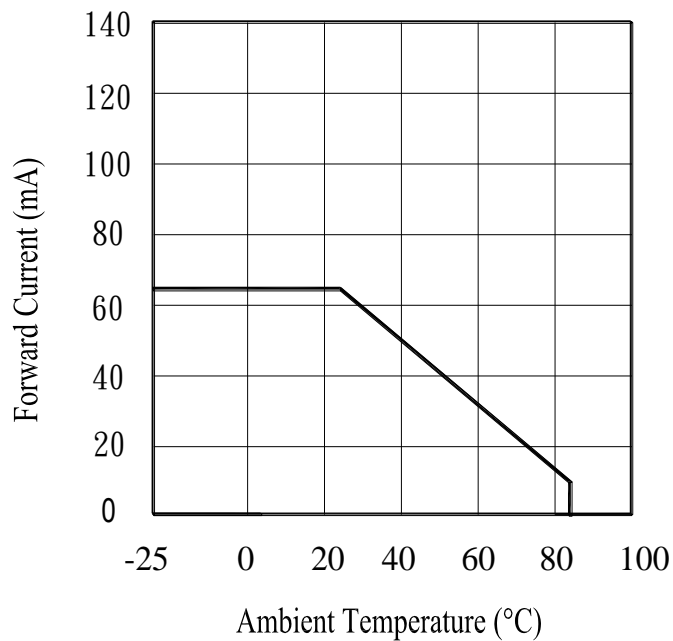


Fig.2 Spectral Distribution

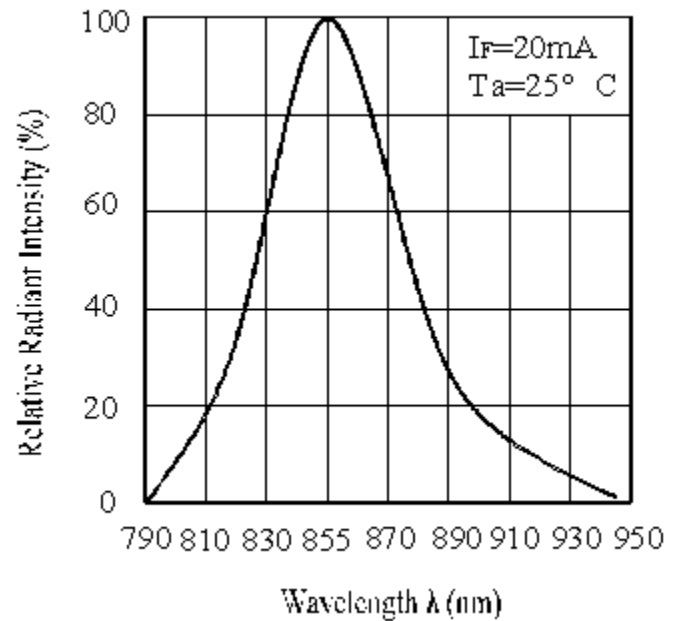


Fig.3 Peak Emission Wavelength
Ambient Temperature

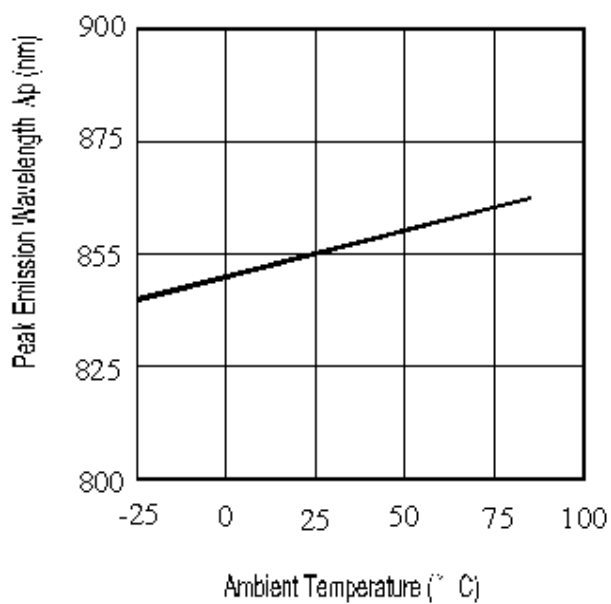
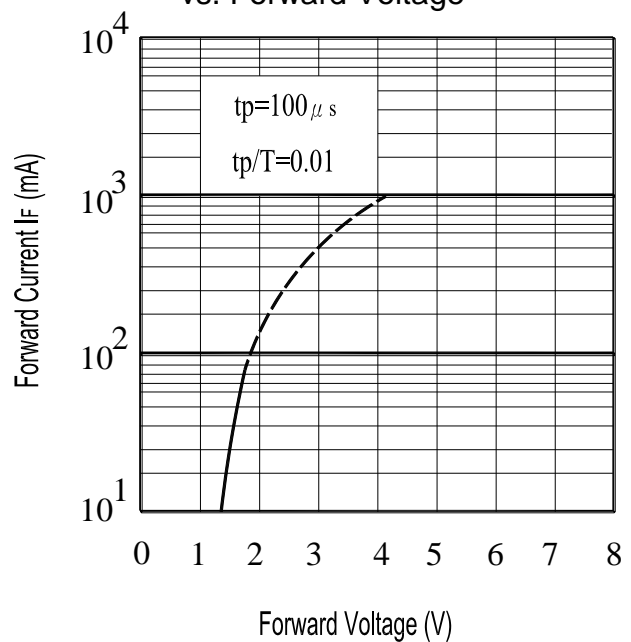


Fig.4 Forward Current
vs. Forward Voltage



Typical Electro-Optical Characteristics Curves

Fig.5 Relative Intensity vs.

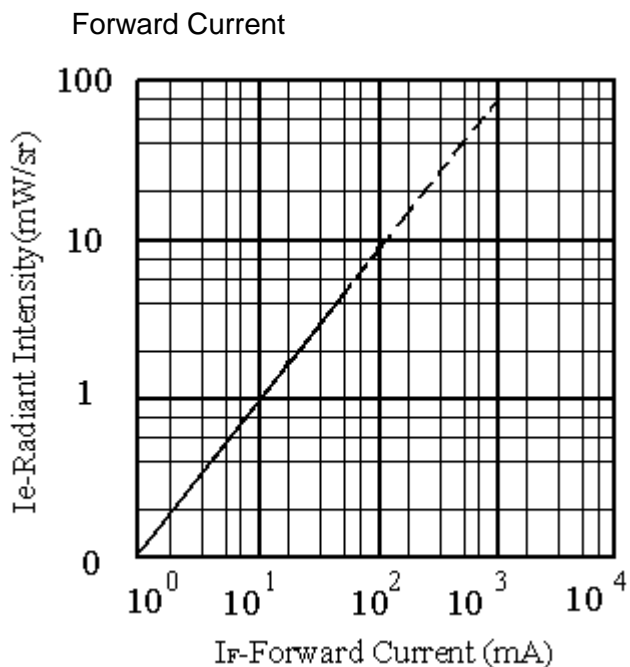
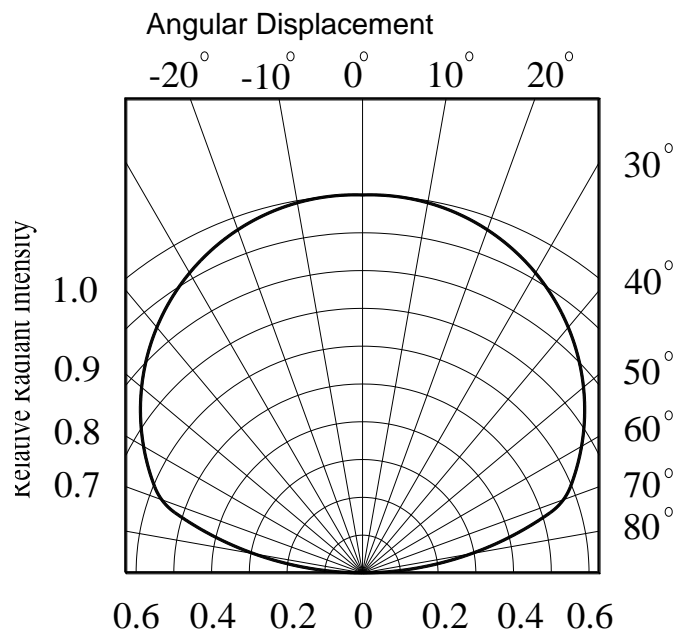


Fig.6 Relative Radiant Intensity vs.



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.

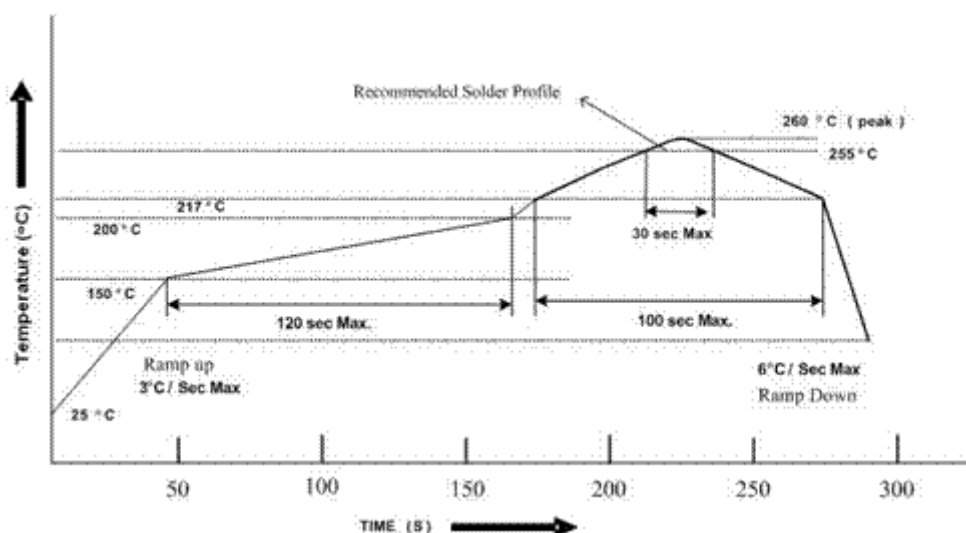
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 48 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

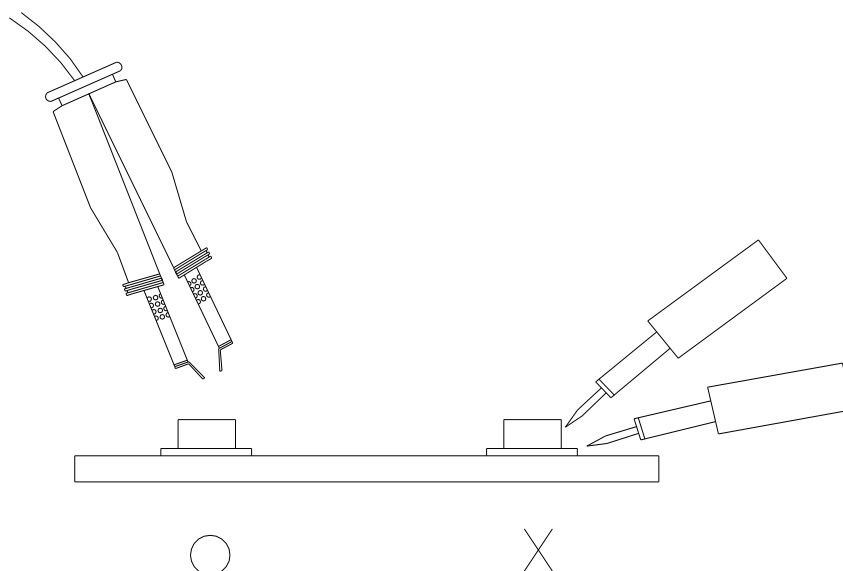
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

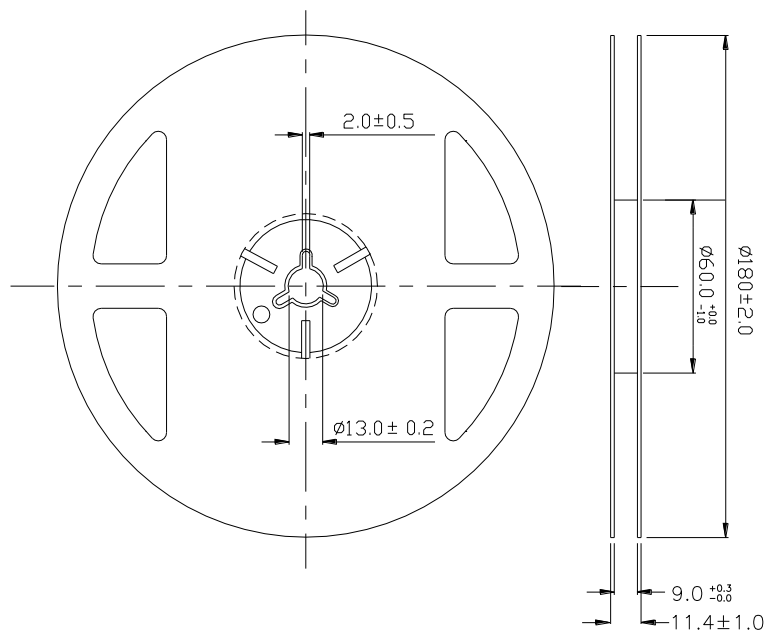
Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

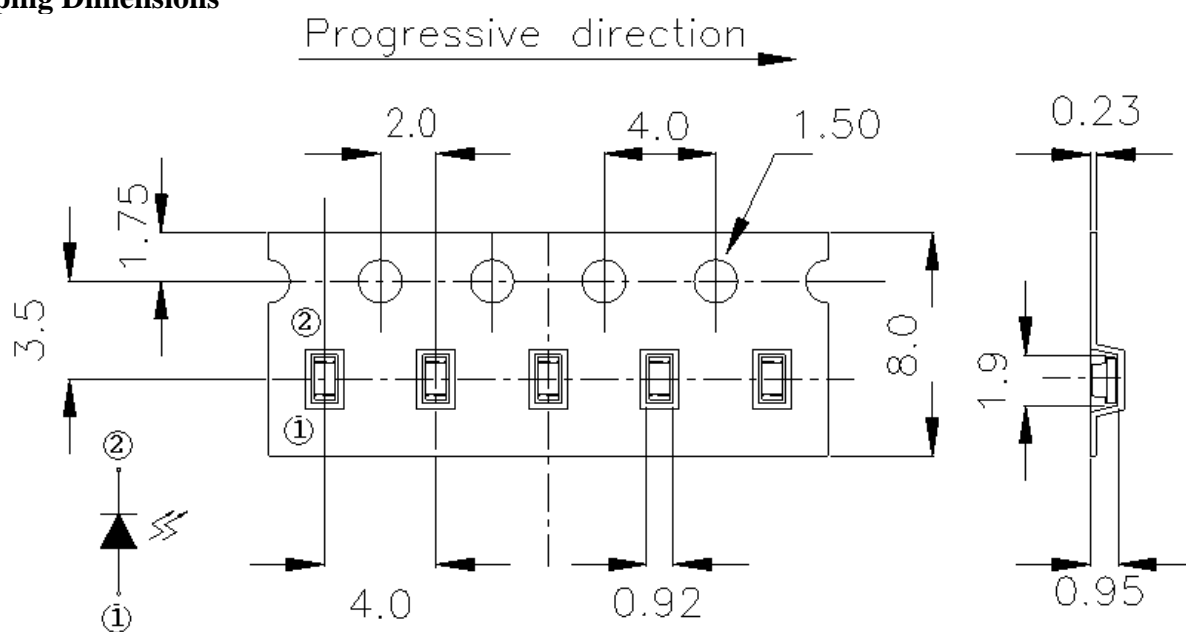


Package Dimensions



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Taping Dimensions



Unit:mm

Label Form Specification

The diagram shows a rectangular label with the following elements:

- Top left: A circle containing the letters "Pb".
- Top center: A rectangular box containing the text "EVERLIGHT AMERICA".
- Top right: An empty circle.
- Below "Pb": The text "CPN: XXXXXXXXXX" followed by "P/N: XXXXXXXXXX".
- Below "P/N": A barcode.
- Below the first barcode: The text "XXXXXXXXXXXXXXXXXXXX".
- Below the second barcode: The text "QTY: XXXX" followed by "CAT: XXX", "HUE: XXX", and "REF: XXX".
- Below the third barcode: The text "LOT NO: XXXXXXXXXXXXXXXXXXXX".
- Below the fourth barcode: The text "REFERENCE: XXXXXXXXXX".
- Below the fifth barcode: The text "MADE IN TAIWAN".
- On the right side, below the "P/N" field: A rectangular box containing the text "RoHS".

CPN: Customer's Production Number

P/N : Production Number

QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

Notes

1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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